



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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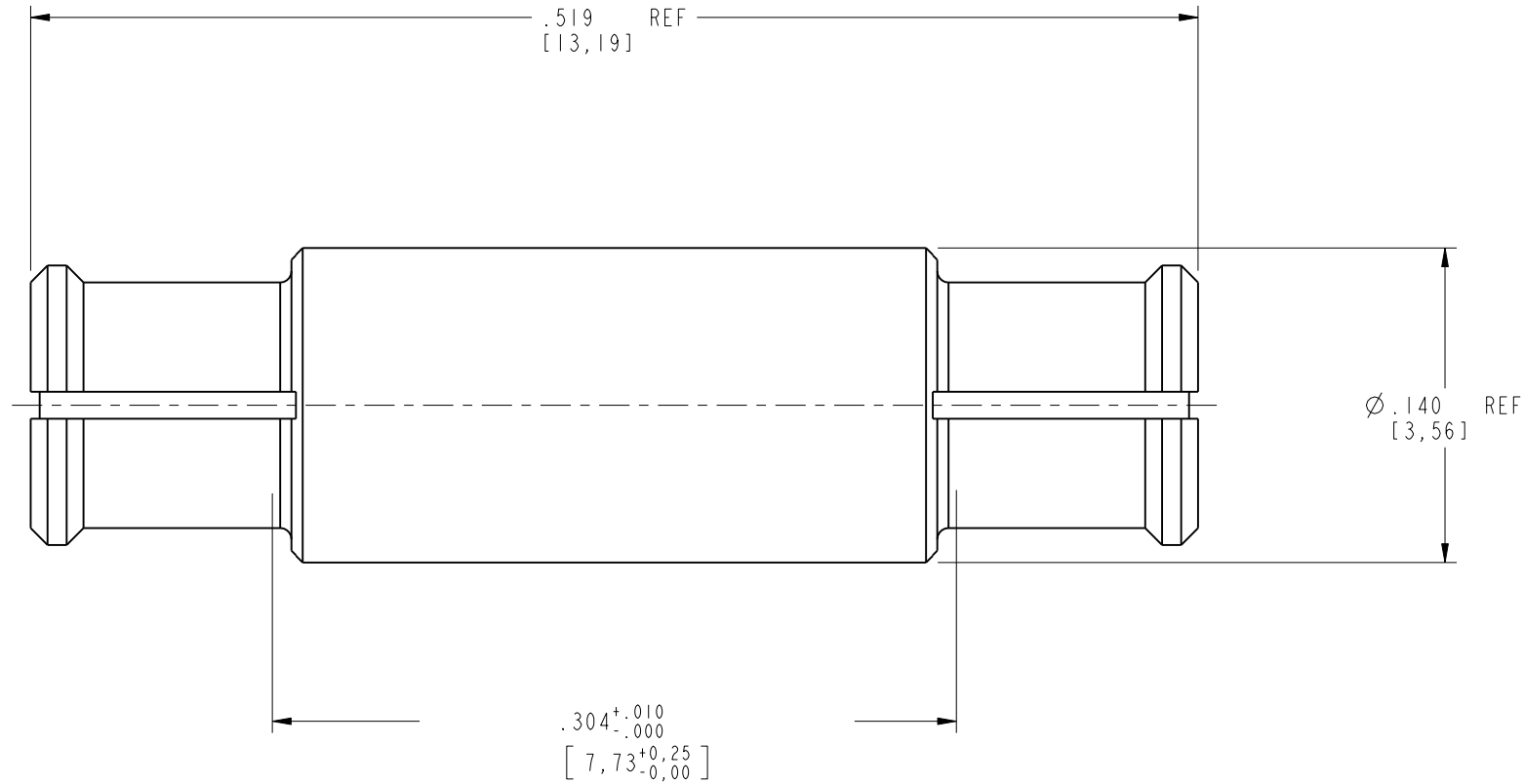
1. MATERIALS AND FINISHES:
BODY - BeCu, GOLD PLATING, .000030 [0.8] THICK OVER NICKEL
CONTACT - BeCu, GOLD PLATING, .000030 [0.8] THICK OVER NICKEL
INSULATOR - PTFE

A. IMPEDANCE: 50 OHM
B. FREQUENCY RANGE: DC - 26.5 GHz
C. VSWR(RETURN LOSS): 1.2 (20.8 dB), MAX. DC-10GHz
1.4 (15.6 dB), MAX. 10-18GHz
1.5 (14 dB), MAX. 18-26.5GHz
D. DIELECTRIC WITHSTANDING VOLTAGE: 500 VRMS, MIN.

A. DURABILITY: 100 CYCLES MIN.
B. ENGAGEMENT FORCE: 15 LB [67 N] MAX
C. DISENGAGEMENT FORCE: 2 LB [9 N] MIN
E. TEMPERATURE RANGE: -65° C TO 165° C

A. QUANTITY: SINGLE PACK
B. MARKING: AMPHENOL, SMP-FSBA-131, DATE CODE

REV	DESCRIPTION	DATE	ECO	APPR
A	RELEASE TO MFG	6/25/09	47636	TRC



CUSTOMER OUTLINE DRAWING

ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN METRIC AND TOLERANCES ARE: <0.5mm 0.5 - 6mm 6 - 30mm 30 - 120mm ANGLES ± 0.05mm ±0.1mm ±0.2mm ± 0.3mm ±1°	MATERIAL -	DRAWN K. LI	DATE 15-May-09	TITLE ASSEMBLY SMP, M-M		Amphenol RF Danbury CT USA, Tainan, Taiwan, Shenzhen, China www.amphenolrf.com	
NOTICE - These drawings, specifications, or other data (1) are, and remain the property of Amphenol corp. (2) must be returned upon request; and (3) are confidential and not to be disclosed to any person other than those to whom they are given by Amphenol Corp. the furnishing of these drawings, specifications, or other data by Amphenol Corp., or to any other person to anyone for any purpose is not to be regarded by implication or otherwise in any manner licensing, granting rights to permitting such holder or any other person to manufacture, use or sell any product, process or design, patented or otherwise, that may in any way be related to or disclosed by said drawings, specifications, or other data.		ENGINEER T. COVERSTONE	DATE 15-May-09			DRAWING NO. SMP-FSBA-131	
		REFERENCE EAR # 1919 AND 615X-1718	APPROVED K. CAPOZZI			DATE 6/25/09	SCALE: 12.0:1.0
		CONFIGURATION LEVEL: Prototype	CAD FILE Root Folder/SMP/SMP-FSBA-131		DWG SIZE B	REV A	
		FINISH					ITEM NO. SMP-FSBA-131
						PART NO. SMP-FSBA-131	